AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application.

- 1. (Withdrawn) A chemical vapor reaction apparatus comprising:
 - a fluid input portion;
- a vapor chamber, said vapor chamber fluidically coupled to said fluid input portion; and
- a process chamber, said process chamber fluidically coupled by a first chemical vapor delivery line to said vapor chamber.
- 2. (Withdrawn) The chemical vapor reaction apparatus of claim 1 wherein said fluid input portion comprises one or more fluid withdrawal portions.
- 3. (Withdrawn) The chemical vapor reaction apparatus of claim 1 wherein said fluid input portion comprises one or more chemical reservoirs.
- 4. (Withdrawn) The chemical vapor reaction apparatus of claim 2 wherein said fluid withdrawal portion comprises a first syringe pump.
- 5. (Withdrawn) The chemical vapor reaction apparatus of claim 4 wherein said fluid withdrawal portion further comprises:
- an input line coupled to said first syringe pump and adapted to receive fluid from a first chemical reservoir; and

a first isolating valve, said first isolating valve located to fluidically isolate said first chemical reservoir from said first syringe pump.

- 6. (Withdrawn) The chemical vapor reaction apparatus of claim 5 further comprising:
- a first output line adapted to deliver fluid from said first syringe pump to said vapor chamber; and

a second isolating valve, said second isolating valve located to fluidically isolate said first syringe pump from said vapor chamber.

- 7. (Withdrawn) The chemical vapor reaction apparatus of claim 1 further comprising a vacuum inlet line, said vacuum inlet line fluidically coupled to said process chamber.
- 8. (Withdrawn) The chemical vapor reaction apparatus of claim 7 wherein said vacuum inlet line is fluidically coupled to said vapor chamber.
- 9. (Withdrawn) The chemical vapor reaction apparatus of claim 8 further comprising a vapor chamber heater.
- 10. (Withdrawn) The chemical vapor reaction apparatus of claim 8 further comprising a vapor chamber isolation valve, said vapor chamber isolation valve adapted to fluidically isolate said vapor chamber from said process oven.

- 11. (Withdrawn) The chemical vapor reaction apparatus of claim 10 further comprising a first limit switch, said first limit switch adapted to regulate the pressure in said vapor chamber.
- 12. (Withdrawn) A chemical vapor reaction apparatus comprising:
 - a vacuum chamber;
- a vapor chamber, said vapor chamber fluidically coupled to said vacuum chamber, said vapor chamber fluidically isolatable from said vacuum chamber; and
- a chemical delivery system, said chemical delivery system fluidically coupled to said vapor chamber, said chemical delivery system fluidically isolatable from said vapor chamber.
- 13. (Withdrawn) The chemical vapor reaction apparatus of claim 12, further comprising a gas delivery system, said gas delivery system fluidically coupled to said vacuum chamber, said gas delivery system fluidically isolatable from said vacuum chamber.
- 14. (Withdrawn) The chemical vapor reaction apparatus of claim 13, further comprising a vacuum delivery system, said vacuum delivery system fluidically coupled to said vacuum chamber.
- 15. (Withdrawn) The chemical vapor reaction apparatus of claim 14, wherein said vacuum system is fluidically coupled to said vapor chamber.
- 16. (Withdrawn) The chemical vapor reaction apparatus of claim 12 wherein said vapor chamber comprises a vapor chamber heater.

- 17. (Withdrawn) The chemical vapor reaction apparatus of claim 16 wherein said chemical delivery system is adapted to deliver a first amount of a first chemical to said vapor chamber.
- 18. (Withdrawn) The chemical vapor reaction apparatus of claim 17 wherein said chemical delivery system is adapted to deliver a second amount of a second chemical to said vapor chamber.
- 19. (Withdrawn) The chemical vapor reaction apparatus of claim 17 wherein said gas delivery system comprises a gas heating portion.
- 20. (Amended) A process for coating of substrates comprising:

inserting a substrate into a process chamber;

supplying a first chemical to a heated vaporization chamber;

vaporizing said first chemical; and

supplying the vapor of said first chemical to a process chamber, thereby coating said substrate with said first chemical.

- 21. (Original) The process of claim 20 further wherein said supplying a first chemical comprises withdrawing said first chemical from a first chemical reservoir.
- 22. (Original) The process of claim 21 wherein said withdrawing said first chemical comprises withdrawing a specific volume of said first chemical from said first chemical reservoir.

- 23. (Original) The process of claim 21, wherein said first chemical reservoir is a chemical manufacturer's source bottle.
- 24. (Original) The process of claim 20 further comprising dehydrating a substrate.
- 25. (Original) The process of claim 24, wherein said dehydrating a substrate comprises: inserting said substrate into said process chamber; evacuating said chamber to a first pressure; inputting a first gas into said process chamber.
- 26. (Original) The process of claim 25 wherein said first gas is an inert gas.
- 27. (Original) The process of claim 26 wherein said inert gas is nitrogen.
- 28. (Original) The process of claim 25 wherein said first gas is heated.
- 29. (Original) The process of claim 25 further comprising re-evacuating said process chamber subsequent to said inputting a first gas into said process chamber.
- 30. (Original) The process of claim 29 wherein said re-evacuating said process chamber evacuates said process chamber to a second pressure.
- 31. (Original) The process of claim 30 wherein said second pressure is lower than said first pressure.

- 32. (Original) The process of claim 20 further comprising:
 supplying a second chemical to a heated vaporization chamber;
 vaporizing said second chemical; and
 supplying the vapor of said second chemical to said process chamber.
- 33. (Original) The process of claim 20 wherein said vaporizing said first chemical occurs in a first vaporization chamber.
- 34. (Original) The process of claim 33 wherein said vaporizing said first chemical comprises heating said first chemical.
- 35. (Original) The process of claim 33 wherein said vaporizing said first chemical comprises exposing said first chemical to reduced pressure.
- 36. (Original) The process of claim 34 wherein said vaporizing said first chemical further comprises exposing said first chemical to reduced pressure.
- 37. (Original) The process of claim 32 wherein said vaporizing said first chemical occurs in a first vaporization chamber.
- 38. (Original) The process of claim 37 wherein said vaporizing said second chemical occurs in said first vaporization chamber.
- 39. (Original) The process of claim 38 wherein said vaporizing said first chemical and said vaporizing said second chemical occur relatively simultaneously.

40. (Amended) A process for the coating of a substrate comprising:

inserting a substrate into a process chamber;

dehydrating said substrate;

delivering a first amount of a first chemical to a vaporization chamber;

vaporizing said first chemical; and

delivering the vaporized first chemical into said process chamber, thereby coating said substrate with said first chemical.

- 41. (Original) The process of claim 40, wherein said substrate comprises glass.
- 42. (Original) The process of claim 40, wherein said first chemical comprises silane.
- 43. (Original) The process of claim 42 wherein said silane is an amino silane.
- 44. (Original) The process of claim 42 wherein said silane is an epoxy silane.
- 45. (Original) The process of claim 42 wherein said silane is a mercapto silane.
- 46. (Original) The process of claim 40 wherein said delivering a first amount of a first chemical to a vaporization chamber comprises:

withdrawing a first amount of a first chemical from a first chemical reservoir; and delivering said first amount of a first chemical to said vaporization chamber.

- 47. (Original) The process of claim 46 wherein said chemical reservoir is a chemical source bottle.
- 48. (Original) The process of claim 46 further comprising replacing the lost volume of chemical in the first chemical reservoir with an inert gas.
- 49. (Original) The process of claim 48 wherein said inert gas is nitrogen.
- 50. (Original) The process of claim 46 wherein said withdrawing a first amount of a first chemical comprises withdrawing said first amount using a syringe pump.